



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Type: **PCB Mount Receptacle**

PCB Mount Orientation: **Vertical**

Connector System: **Board-to-Board**

Number of Positions: **4**

Number of Rows: **1**

Features

Product Type Features

Connector Shape	Rectangular
PCB Connector Type	PCB Mount Receptacle
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly

Configuration Features

Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	4
Number of Rows	1

Body Features

Connector Profile	Standard
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Primary Product Color	Black
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Contact Features

Contact Underplating Material	Nickel
Mating Pin Diameter	.63 mm[.024 in]
Contact Underplating Material Thickness	1.3 µm[50 µin]
Contact Mating Area Plating Material Thickness	.76 µm[30 µin]
Mating Square Post Dimension	.63 mm[.024 in]
PCB Contact Termination Area Plating Material Thickness	3 – 5 µm[118.11 – 196.85 µin]
Contact Shape & Form	Square
Contact Layout	Inline
Contact Protection Type	Closed Entry Housing
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material	Gold (Au)
Contact Type	Socket
Contact Current Rating (Max)	3 A

Termination Features

Rectangular Termination Post & Tail Width	.69 mm[.027 in]
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Termination Post & Tail Length	3.1 mm[.122 in]
Termination Method to PCB	Through Hole - Solder

Mechanical Attachment

PCB Mount Retention Type	Kinked Solder Tails
PCB Mount Retention	With
Connector Mounting Type	Board Mount

Housing Features

Mating Entry Location	Top
Housing Material	Polyester - GF
Centerline (Pitch)	2.54 mm[.1 in]

Dimensions

PCB Thickness (Recommended)	1.6 mm[.063 in]
Connector Height	7 mm[.276 in]



Usage Conditions

Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
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Operation/Application

Solder Process Feature	Board Standoff
Circuit Application	Signal

Industry Standards

UL Flammability Rating	UL 94V-0
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Packaging Features

Packaging Quantity	184
Packaging Method	Carton

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) ‘Guidance on requirements for substances in articles’ posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



TE Part # 966710-4
MODU II PIN HEADER, SGL ROW,
SMD- 4 POS



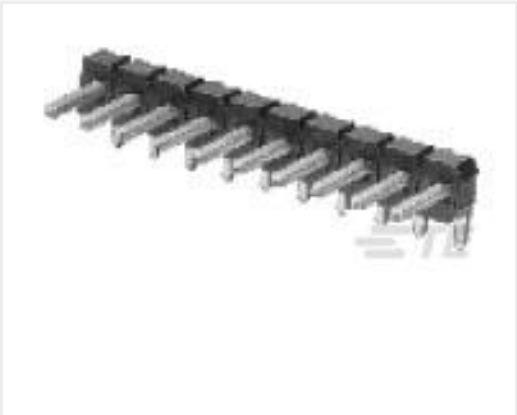
TE Part # 826648-4
4P AMPMODU II STIFT LEI



TE Part # 826651-4
4P AMPMODU II STIFT LEI



TE Part # 966306-4
MOD2 ST-LEI SMD 4P



TE Part # 826654-4
4P AMPMODU II STIFT LEI



TE Part # 1241150-4
4P MOD II BREAK AWAY HDR , SMD,
BLISTER



TE Part # 826631-4
4P AMPMODU II PIN HEADER



TE Part # 826646-4
4P AMPMODU II STIFT LEI



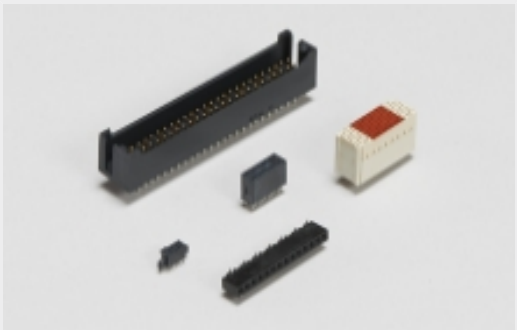
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4P AMPMODU II STIFT LEI



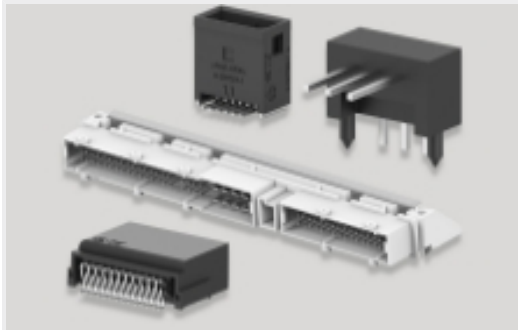
TE Part # 826629-4
4P AMPMODU II PIN HSG

Also in the Series |

AMPMODU HV-100/HV-190



Board-to-Board Headers &
Receptacles(321)



PCB Headers & Receptacles(321)

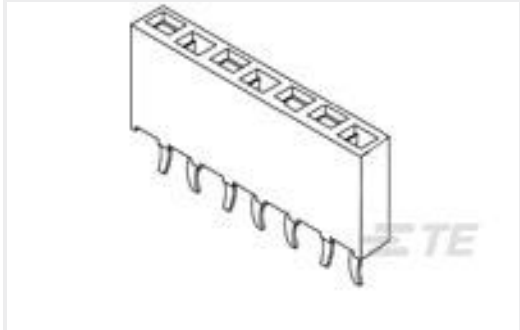
Customers Also Bought



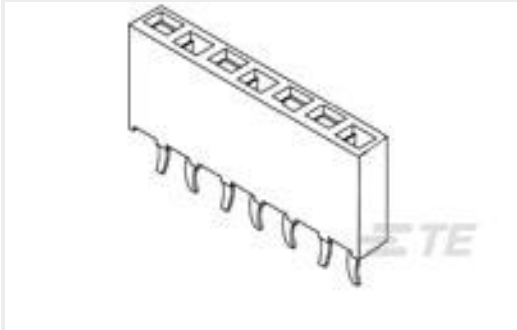
TE Part #1-794069-1
18P MINI UMNL HDR W/DH AU LF



TE Part #11028730-00
44030RC,THERM,ROHS

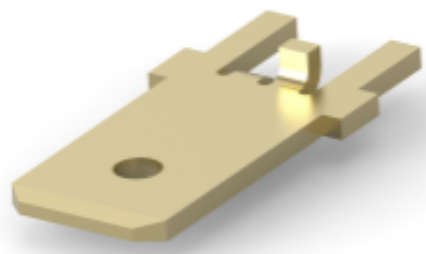


TE Part #215297-7
7P HV100 REC CON. TE, 7.0MM

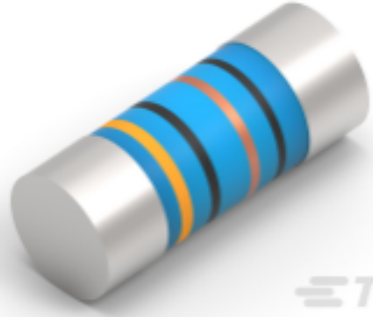


TE Part #1-215297-2
12P HV100 REC CON. TE, 7.0MM

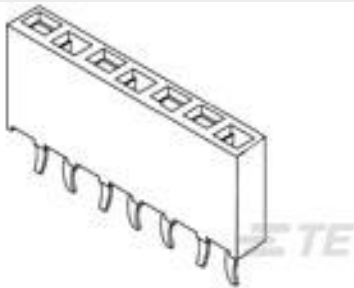




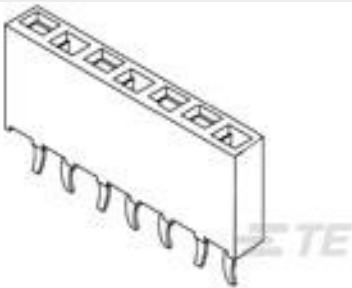
TE Part #1217126-2
250 FASTON,PCB TAB,TPBR



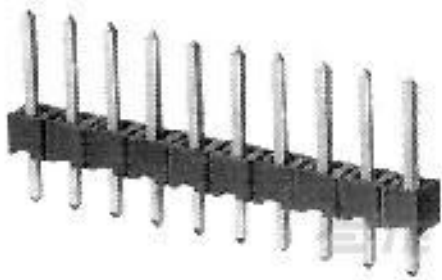
TE Part #8-2176316-9
MELF SMA-A 120K 1% 50PPM 0207 1W



TE Part #215297-5
5P HV100 REC CON. TE, 7.0MM



TE Part #215297-3
3P HV100 REC CON. TE, 7.0MM



TE Part #828214-8
8P MOD2 STIFT LEI

TE Part #W330TF11-23PA-151
SQ FLNG REC ASSEMBLY NO REAR ACCESSORY W

Documents

Product Drawings

4P HV100 REC CON. TE, 7.0MM

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_215297-4_E.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_215297-4_E.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_215297-4_E.3d_stp.zip

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Product Specifications

Product Specification

English